

Component Title:

Transistor Bipolar NPN low and high power

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Appl. No.

		Executive M	ember: C	NES		Da	ate: 16/07/2018	233M	
Components (including	ng series and familie	s) submitted fo	or Extension o	of Qualification	Approval:				1
ESCC COMPONENT NO.	VARIANTS RANG		RANGE OF COMPONENTS		BASED ON		TEST VEHICLE / S	COMPONEN SIMILAR	Т
5201/001 5201/002 5201/019 5201/004	01 to 07 01,02,04,05,11,12 01,02,04,05,08,09 01,02,04 to 07	E MANUAL MANUEL CONTROL	er: TO-18, LC	CC3, LCC3+1 2N2484 2N2222A 2N5551 2N3700			2N222AHRG		
5201/003 5201/011	01,02 03,04	Low pow	er: TO-39		2N2219 2N3019				
5203/010 5203/016				7, SMD.5, TO-39 2N5154 BUX77ESY			2N5154ESYHRT 2N5154SHRG		
5207/002	03,06,12,15, 16, 1	7 Dual mai	Dual matched: TO-77, LCC6, FP-8D 2N2920A			. 1			
Component M			***	ufacturing Plan			,		4
STMicroelectronics	_	3, rue de Suisse BP4199, 35041 Rennes Cedex			Date of original qualification approval: Date: 02/09/1996 Certificate Ref No. 233				
		5			6				7
ESCC Specifications Maintenance of quali	fication testing:	Deviation used:	Deviations to LVT testing and Detail Specification used:			Qualification Extension Report reference and date:			
Generic: 5000	Issue: 7	No E	No ⊠ Yes ☐ (supply details in Box 15)			RNS/AN/18-191-02/ce Rev 2 11th July 2018 (appended)			
Detail(s): 5201/00 5201/00 5201/00 5201/00 5201/01 5203/01 5203/01 5203/01	3 4 4 6 1 4 9 6 0 7 6 4	No §	V	t Specifications ☐ (Supply	details)				
									8
Summary of procure	ment or equivalent to	est results durir	ng current val	lidity period in s	support of this ap	plicatio	n (those to ESCC listed fir	rst)	
Project Name	Testing Lev	/el	LAT		Date code		Quantity	Delivered	
See appendix to maintenance report									
PID changes since s	tart of qualification		9	Current PID	Verified by:		CNES		10
None						N	ame of Excutive Represer	ntative	
				Ref No: 8097046 (gene			eric) Rev 18 and 8124528 (specific Bipolar) rev 19		
Minor* ⊠				Nei No.	COST 040 (gene				
Major* □	*Provide details in	box:		Issue: Rev Date:			Date:	16/07/2018	r
Current Manufacturii	ng facilities surveyed	I by:		CNES		on	1 27/	/03/2018	11
	**************************************		(Name	of Executive F	Representative)		((Date)	
Satisfactory:	Yes ⊠	No	□ Ехр	lain					
Report Reference:	CR-ST-27-03-	-2018							

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL Page 2 Component title: Transistor Bipolar NPN low and high power Appl. No. Executive Member: CNES Date: 16/07/2018 12 Failure Analysis, DPA, NCCS available: Yes No \boxtimes (Supply data) Ref. No's and purposes: 13 The undersigned hereby certifies on behalf of the ESCC Executive - that the above information is correct; that the appropriate documentation has been evaluated; - that full compliance to all ESCC requirements is evidence (except as stated in box 15;) - that the reports and data are available at the ESCC Executive and therefore applies on behalf of CNES as the responsible Executive Member for ESCC qualification status to be extended to the component(s) listed herein. Date: 24/07/2018 JP. BUSSENOT (Signature of the Executive Coordinator) Continuation of Boxes above: 14

2N2907AHRG DC1709 : covers TO16 packages
2N5154ESYHRT DC 1712 : covers TO257 packages
2N3810HRT DC1629 : covers TO77/TO78 packages
2N3810KT DC 1713 : covers FLAT8 packages
2N38153HRT DC1709 : covers TO39 packages
2N5153HRT DC1709 : covers TO39 packages
2N5153SHRG DC1630 & 2N5154SHRG: covers SMD.5 packages (parallel seam welding and belt furnace sealing)

2N2907AHRG DC1709 : covers TO18 packages

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Non compliance to ESCC requirements:			
No.: Specification	Paragraph	Non compliance	
		N	
Additional tasks required to achieve full compliance for noncompliance:	ESCC qualification or rationale for acceptability	of	16
noncompilance.			
Executive Manager Disposition			17
Application Approval: Yes 📈 No 🗆			
Action / Remarks:			
Addit Actions.			
		201	
		3. 81	
Date:			
		B. Schade, Head of Product Assurance And Safety Department - ESA Representative	



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ANNEX 1: LIST OF TESTS DONE TO SUPPORT EXTENSION OF QUALIFICATION

Tests conducted in compliance with:

ESCC 5000 generic specification; Chart F4 (for ESCC/QPL parts);

or PID-TFD (for ESCC/QML parts)

Tests vehicle identification/description:

2N222AHRG (TO18 DC 1712): Endurance	2N5154ESYHRT (TO257 DC1712): Full F4
2N5154SHRG (SMD,5 DC 1734): Endurance	

Detail Specification reference:

See box 5

Chart F4	Test	Tick when done	Conditions	Date Code Diffusion Lot	Tested Qty	N° of Rejects	Comments if not performed Comments on Rejection
	Mechanical shock	\boxtimes	MIL-STD-750 TM2016	1712	15	0	
	Vibration		MIL-STD-750 TM2056	1712	15	0	
Environmental/Mechanical Subgroup	Constant acceleration	×	MIL-STD-750 TM2006	1712	15	0	
	Seal Fine leak Gross leak		MIL-STD-750 TM1071	1712	15	. 0	
	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1712	15	0	
anic	External Visual	⊠	ESCC Basic Spec 20500	1712	15	0	
al/Mech	Thermal shock		MIL-STD-750 TM1056	Click here to enter text.			Only applicable to axial lead glass diodes
ents	Temperature Cycling	×	MIL-STD-750 TM1051	1712	15	0	
onn	Moisture Resistance	⊠	MIL-STD-750 TM1021	1712	15	0	
Envir	Seal Fine leak Gross leak	×	MIL-STD-750 TM1071	1712	15	0	
	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1712	15	0	
	External Visual	×	ESCC Basic Spec 20500	1712	15	0	
	Operating Life	×	ESCC 5000 Para, 8,19	1712 (2) 1734	15+15+15	0	
Endurance Subgroup	Electrical Measurement	×	Intermediate and End- Point Electrical Measurements	1712 (2) 1734	15+15+15	0	
Endu	Seal Fine leak Gross leak	×	MIL-STD-750 TM1071	1712 (2) 1734	15+15+15	0	
	External Visual Inspection	×	ESCC Basic Spec 20500	1712 (2) 1734	15+15+15	0	
	Permanence of Marking		ESCC Basic Spec 24800				Not applicable on Laser marking
ility	Terminal Strength	×	ESCC 5000 Para. 8.18	1712	5	0	
Assembly Capability Subgroup	Internal Visual	×	ESCC Basic Spec 20400	1712	5	0	
As Ca Su	Bond Strength	×	MIL-STD-750 TM 2037	1712	3	0	
	Die Shear	×	MIL-STD-750 TM 2017	1712	3	0	



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Chart	Test	Tick when	Conditions	Date Code Diffusion Lot	Tested	N° of	Comm	nents if not formed. on Rejection
F4		done	done		Qty	Rejects	Comments	on Rejection
Additional	RGA							£
∢								



Box 20

Box 21

Box 22

Additional Comments.

APPLICATION FOR EXTENSION OF ESCC QUALIFICATION APPROVAL

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Executive Member:

CNES

ES Date: 16/07/2018

NOT	ES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC QUALIFICATION EXTENSION APPROVAL
ENTRIES Form heading	shall indicate: - the title of the component as given in its detail specification or the name of the series, family; - the Executive Member; - the entering date; - the certificate number and its sequential suffix.
Box 1	shall provide details given in the table; in particular there shall be listed: - the variants or range of variants; - the range of components (the ESCC code is recommended to indicate the values or values range, the tolerance, the voltage, etc); the designation given in the detail specification as 'base on'; - under Test Vehicle enter either an ESCC code or the specific characteristic capable of identifying the component tested (e.g., voltage of coil for a relay); - under component similar enter a cross if relevant.
Box 2; 3 and 4	As per QPL entry; otherwise, an explanation of the changes must be supplied.
Box 5	Will show the ESCC Generic and Detail specifications, including issue number and revision letter, current at the time the tests reported were performed. If the specifications are different from those current on the date of the application, see Box 6.
Box 6	Will show the deviations from the Generic and Detail Specifications listed in Box 5, in particular deviations from testing. In case of deviations this must be listed in Box 15. In case the referenced specification in Box 5 have currently a different issue and/or revision indicate also whether the test data deviates or not from such current documents.
Box 7	Must reference the report(s) supplied in support of the application.
Box 8	Should provide the details of procurement to the full ESCC System, documentation of all of which should already have been delivered to the ESCC Executive under the terms of the relevant Generic Specification. An appropriate table has been drawn in this box.
Box 9	If the PID evolved after the Original Qualification or after the last Extension of Qualification, adequate details of such evolution shall be provided together with the reasons for the changes. Major changes shall be clearly marked.
Box 10	Identify the current PID issue status, date and actual date of verification. The date of verification of the current PID should be arranged as close as possible to the required date of extension.
Box 11	This box can be completed only after a physical visit to the plant to confirm that no unexplained changes occurred and that the practices, procedures, material, etc. used in manufacturing the components are as described in the PID. This survey shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and its findings shall be recorded.
Box 12	Provide details of, or reference to, any Destructive Physical Analysis (DPA) and Failure Analysis reports as well as any Nonconformance(s) (NCCS) occurred during the qualification validity period, stating if established corrective action have produced satisfactory results.
Box 13	Enter only the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature of the responsible Executive Coordinator.
Box 14	To be used when there is a need to expand any of the boxes from 1 through 12. Identify box affected and reference the Box 14 in the relevant Box. Box 14 can be broken into 14a, 14b, etc. if several boxes have to be expanded.
Box 15	Fill in Table as requested.
Box 16	Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.
Box 17	All Executive Manager recommendations on the application itself, special conditions or restrictions, modifications of the QPL or QML entry, letters to the manufacturer, etc. shall be entered clearly in Box 19, signed by the representative for ESA, and dated.
Box 18	Fill in Table as requested.
Box 19	Confidential Details of PID changes including those of a confidential nature, shall be provided.

State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 16 each nonconformance shall be sequentially numbered. If relevant state 'None'.

Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the noncompliance.